19-0531; Rev 2; 1/09 查询"MAX9508"(# EVALUATION KIT AVAILABLE



CVBS/S-Video Filter Amplifier with SmartSleep and Bidirectional Video Support

General Description

The MAX9508 video filter amplifier with SmartSleep and bidirectional video support is ideal for set-top boxes (STBs), portable DVD players, and portable media players (PMPs). The inputs can be directly connected to the digital-to-analog converter (DAC) outputs. The reconstruction filter removes high-frequency signals above 6.75MHz. The amplifiers have 6dB of gain, and the outputs can be DC-coupled to a load of 75 Ω , which is equivalent to two video loads, or it can be AC-coupled to a load of 150 Ω .

The SmartSleep circuitry intelligently reduces power consumption based on the presence of the input signal and the output loads. When the MAX9508 does not detect the presence of sync on the input video signal, the supply current is reduced to less than 7µA. The device only enables a video amplifier when there is an active video input signal and an attached load. The video amplifier remains on while a load is connected. If the load is disconnected, the video amplifier is turned off.

The MAX9508 contains three reconstruction filters, four video amplifiers, and a pulldown switch at one of the two CVBS outputs. The MAX9508 has the ability to control the bidirectional video signals at the CVBS video connections without the need for separate switches or relays. This feature is particularly useful for portable DVD players, which often use the same connector to drive a composite video output and to accept an external video signal to display on the LCD panel.

The MAX9508 operates from a 2.7V to 3.6V single supply and is offered in a small 16-pin TQFN (3mm x 3mm) package. The device is specified over the -40°C to +125°C automotive temperature range.

Applications

Portable DVD Players

Set-Top Boxes (STBs)

Portable Set-Top Boxes/

Personal Video Recorders (PVRs)

Portable Media Players (PMPs)

Portable Applications

Pin Configurations appear at end of data sheet.

Features

- ♦ SmartSleep Feature Detects Input Signal and Output Load Status to Reduce Power Consumption
- ◆ Triple Standard-Definition Video Reconstruction Filters with 6.75MHz Passband
- ◆ Luma, Chroma, and Composite Inputs
- ♦ Luma, Chroma, and Two Composite Outputs
- ◆ Integrated Support for a Bidirectional Composite Video Signal
- ◆ Supports Two Video Loads at Each Output (DC-Coupled)
- ♦ 2.7V to 3.6V Single-Supply Operation

Ordering Information

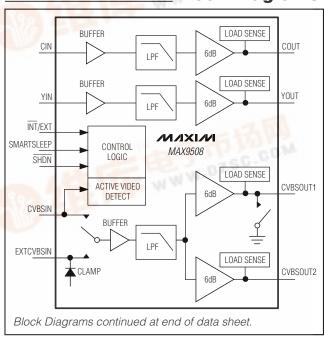
PART	PIN-PACKAGE	TOP MARK
MAX9508ATE+	16 TQFN-EP* (3mm x 3mm)	AEM

Note: Device is specified over the -40°C to +125°C operating temperature range.

+Denotes lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Block Diagrams



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Maxim Integrated Products

ABSOLUTE MAXIMUM RATINGS

(Voltages with respect to GND.)	
VDD0.3V to	+4V
SMARTSLEEP, SHDN, INT/EXT	
CIN, YIN, CVBSIN, EXTCVBSIN0.3V to	+4V
Duration of COUT, YOUT, CVBSOUT1, CVBSOUT2	
Short Circuit to VDD or GNDContinu	ous
Continuous Input Current	
CIN, YIN, EXTCVBSIN, CVBSIN,	
SMARTSLEEP, SHDN, INT/EXT±20)mA

Continuous Power Dissipation (T _A = +70°C)	
16-Pin TQFN (derate 15.6mW/°C above +70°C)	.1250mW
Operating Temperature Range40°C to	o +125°C
Junction Temperature	+150°C
Storage Temperature Range65°C to	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = V_{\overline{SHDN}} = 3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V, R_L = No load. T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)$

PARAMETER	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V_{DD}	Guaranteed by PSRR		2.7		3.6	V
		INT/EXT = GND (4 cha YIN = CVBSIN = 0.3V,	,		13	16	mA
Supply Current		INT/EXT = V _{DD} (1 char EXTCVBSIN is unconn	•		4.3	6	1117 (
	IDD	SMARTSLEEP = V _{DD} , CVBSIN has no active	video signal		7	14	
		SMARTSLEEP = V _{DD} , burst video signal with (Note 2)	1	17		μА	
Shutdown Supply Current	ISHDN	V SHDN = GND			0.01	10	μΑ
SMARTSLEEP CHARACTERIST	ICS						
Minimum Line Frequency		CVBSIN		14.3			kHz
Sync Slice Level		CVBSIN		4.1		5.2	% V _{DD}
Output Load Detect Threshold		Sync pulse present, R	to GND			200	Ω
DC CHARACTERISTICS							
Input Voltago Pango	Visi	CIN, YIN, CVBSIN,	$2.7V < V_{DD} < 3.6V$	0		1.05	V
Input-Voltage Range	VIN	guaranteed by output voltage swing	3.0V < V _{DD} < 3.6V	0		1.2]
Input Current	I _{IN}	CIN = YIN = CVBSIN =		2	5	μΑ	
Input Resistance	R _{IN}	CIN, YIN, CVBSIN		20		МΩ	

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ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = V_{\overline{SHDN}} = 3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V, R_L = No load. T_A = T_{MIN} to T_{MAX}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Sync-Tip Clamp Level	V _{CLP}	EXTCVBSIN			0.25		0.37	V
Input Clamping Current		EXTCVBSIN = 500	EXTCVBSIN = 500mV + V _{CLP}			1	1.5	μΑ
EVTOVDOIN I and A Vallage Day of		Guaranteed by	2.7V	< V _{DD} < 3.6V			1.05	M
EXTCVBSIN Input Voltage Range		output voltage swing	3.0V	< V _{DD} < 3.6V			1.2	V _{P-P}
Sync Crush		EXTCVBSIN, percentage reduction in sync pulse (0.3V _{P-P}), guaranteed by input clamping current measurement, measured at input					2	%
Maximum Input Source Resistance		EXTCVBSIN				300		Ω
DC Voltage Gain	A _V	$R_L = 150\Omega$ to $V_{DD}/2$, $0V \le V_{IN} \le 1.05V$, $V_{DD} = 2.7V$			5.7	6	6.3	dB
DC Gain Matching		$R_L = 150\Omega$ to $V_{DD}/2$, $0V \le V_{IN} \le 1.05V$, $V_{DD} = 2.7V$			-0.2	0	+0.2	dB
		$\begin{split} &\text{YIN} = \text{CVBSIN} = \text{CIN} = 0\text{V}, \\ &\overline{\text{INT}}/\text{EXT} = \text{GND}, \text{R}_{\text{L}} = 150\Omega \text{ to GND} \end{split}$ $&\text{CextCVBSIN} = 0.1 \mu\text{F to GND}, \\ &\overline{\text{INT}}/\text{EXT} = \text{V}_{\text{DD}}, \text{R}_{\text{L}} = 150\Omega \text{ to GND} \end{split}$		0.21	0.3	0.38	V	
Output Level				0.21	0.27	0.38	V	
		Measured at outpo	ut,	$T_A = -40$ °C to $+85$ °C	2.027	2.1	2.163	
		$0V \le V_{IN} \le 1.05V$, $R_L = 150\Omega \text{ to } -0.2V$		$T_A = -40$ °C to $+125$ °C	2.006		2.163	
		Measured at output, $V_{DD} = 2.7V$, $0V \le V_{IN} \le 1.05V$, $R_L = 150\Omega$ to V_{DD} / 2			2.027	2.1	2.163	
Output Voltage Swing		Measured at outpo	ut,	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.316	2.4	2.472	V _{P-P}
		$0V \le V_{IN} \le 1.2V$, $R_L = 150\Omega$ to -0.2	V	$T_A = -40$ °C to $+125$ °C	2.292		2.472	
		Measured at output, $V_{DD}=3V$, $0V \le V_{IN} \le 1.2V$, $R_L=150\Omega$ to $V_{DD}/2$ Measured at output, $V_{DD}=3.135V$, $0V \le V_{IN} \le 1.05V$, $R_L=75\Omega$ to $-0.2V$			2.316	2.4	2.472	
					2.027	2.1	2.163	
Output Resistance	Rout	V _{OUT} = 1.3V, -5m/	A ≤ I _{LO}	AD ≤ +5mA		0.47		Ω

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = V_{\overline{SHDN}} = 3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V, R_L = No load. T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Power-Supply Rejection Ratio	PSRR	$2.7V \le V_{DD} \le 3.6V$, input referred, R _L = 150Ω to GND	48			dB
Output Pulldown Resistance	R _{PD}	INT/EXT = V _{DD} , CVBSOUT1		3.7		Ω
Output Shutdown Impedance				28		kΩ
LOGIC INPUTS (SMARTSLEEP,	SHDN, INT/EX	(T)				
Logic-Low Threshold	VIL				0.3 x V _{DD}	V
Logic-High Threshold	V _{IH}		0.7 x V _{DD}			V
Logic Input Current	IIL / IIH	V _I = 0V or V _{DD}		0.01	10	μΑ

AC ELECTRICAL CHARACTERISTICS

 $(V_{DD} = V_{\overline{SHDN}} = 3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V, R_L = 150\Omega$ to GND. $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	SYMBOL	CONE	ITIONS	1	MIN	TYP	MAX	UNITS
			f = 5.5	f = 5.5MHz		-0.1		
Standard-Definition		Inputs are 1V _{P-P} , reference	f = 6.7	75MHz	-1	-0.3	+1	٩D
Reconstruction Filter		frequency is 1MHz.	f = 11	MHz		-3		dB
			f = 27	MHz	-33	-41		
		DC-coupled output, 5-step modulated staircase		f = 3.58MHz or 4.43MHz		0.2		0/
Differential Gain	DG	AC-coupled output, 5-step modulated staircase		f = 3.58MHz or 4.43MHz	0.4			%
		DC-coupled output, 5-step modulated staircase AC-coupled output, 5-step modulated staircase		C-coupled output, f = 3.58MHz		0.62		
Differential Phase	DP			f = 4.43MHz		0.75		Desires
Dillerential Phase	DP			out, f = 3.58MHz		0.78		Degrees
				f = 4.43MHz	1.01			
2T Pulse Response		2T = 200ns or 250ns				0.2		K%
2T Bar Response		Bar time is 18µs, the beginning 2.5% and the ending 2.5% of the bar time are ignored, 2T = 200ns or 250ns				0.2		K%
2T Pulse-to-Bar K Rating		Bar time is 18µs, the beginnir of the bar time are ignored, 2	-	_		0.3		K%

AC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = V_{\overline{SHDN}} = 3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V, R_L = 150\Omega$ to GND. $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 1)

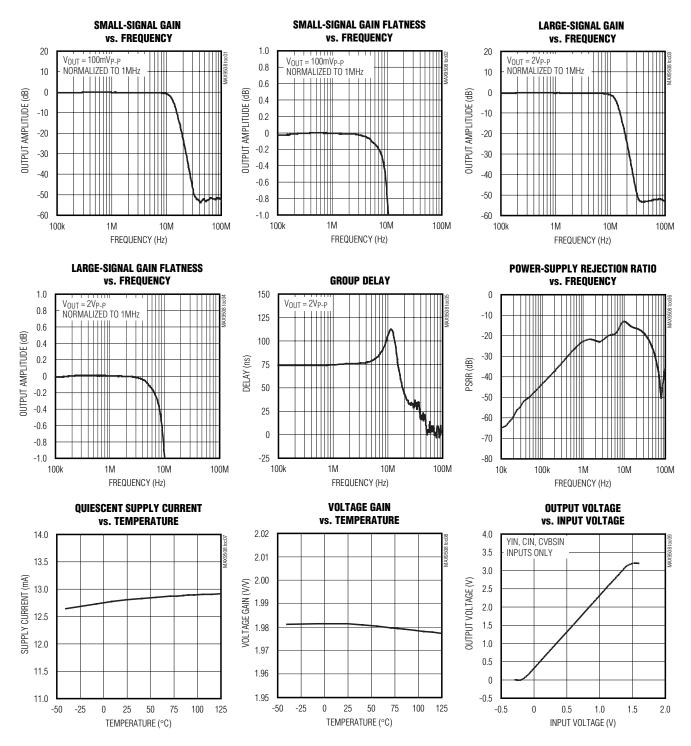
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Nonlinearity		5-step staircase		0.1		
Interchannel Timing Error		Difference in time between the 50% point of the output signals, YOUT to COUT		0.2		ns
Group Delay Distortion		100kHz ≤ f ≤ 5MHz, inputs are 1V _{P-P}		10		ns
Interchannel Group Delay Distortion Error		Inputs are 1V _{P-P}		2		ns
Peak Signal to RMS Noise		100kHz≤f≤5MHz, inputs are 1V _{P-P}	≤f≤5MHz, inputs are 1V _{P-P}			dB
Power-Supply Rejection Ratio		f = 100kHz, 200mV _{P-P} , input referred	43			dB
Output Impedance		f = 5MHz		6		Ω
Enable Time		YIN = 1V, output settled to within 1% of the final voltage, $R_L = 150\Omega$ to GND		13		μs
Disable Time		YIN = 1V, output settled to within 1% of the final voltage, $R_L = 150\Omega$ to GND		1.1		μs
CROSSTALK						
All Hostile Output Crosstalk		f = 4.43MHz		-70		dB
All Hostile Input Crosstalk		$f=4.43 MHz, \overline{SHDN}=GND,$ input termination resistors are 75Ω			dB	

Note 1: All devices are 100% production tested at T_A = +25°C. Specifications over temperature limits are guaranteed by design.

Note 2: Specified current is an average over time.

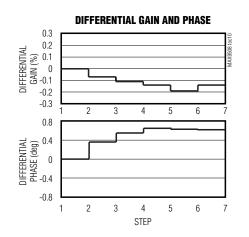
Typical Operating Characteristics

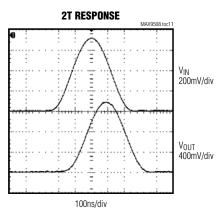
 $(V_{DD} = V_{\overline{SHDN}} = +3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V. R_L = 150\Omega$ to GND. $T_A = +25$ °C, unless otherwise noted.)

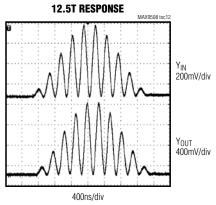


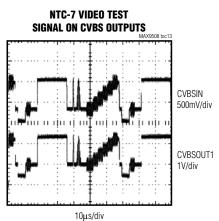
Typical Operating Characteristics (continued)

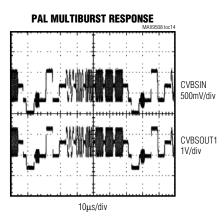
 $(V_{DD} = V_{\overline{SHDN}} = +3.3V, V_{\overline{SMARTSLEEP}} = V_{\overline{INT/EXT}} = V_{\overline{GND}} = 0V. R_L = 150\Omega$ to GND. $T_A = +25^{\circ}C$, unless otherwise noted.)

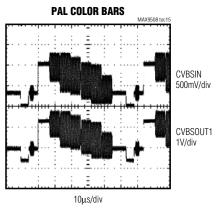


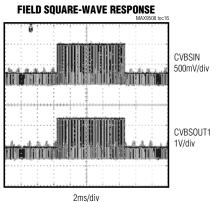


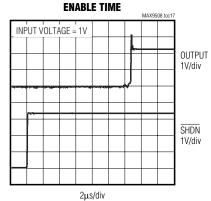


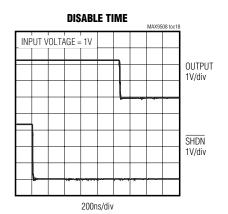






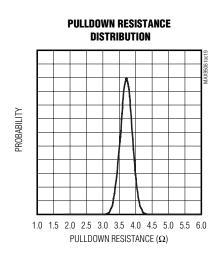


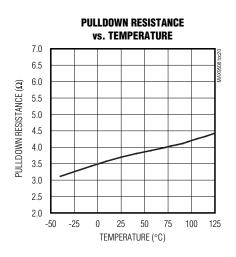


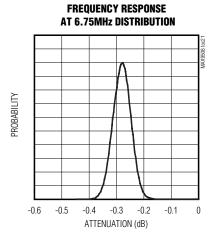


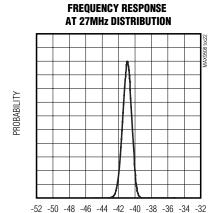
Typical Operating Characteristics (continued)

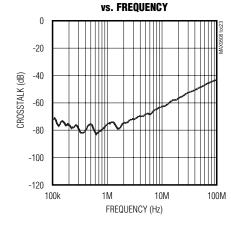
 $(V_{DD} = V_{\overline{SHDN}} = +3.3V, V_{SMARTSLEEP} = V_{\overline{INT}/EXT} = V_{GND} = 0V. R_L = 150\Omega$ to GND. $T_A = +25^{\circ}C$, unless otherwise noted.)







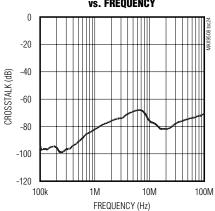




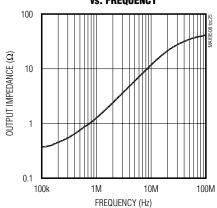
INPUT-TO-INPUT CROSSTALK



ATTENUATION (dB)







Pin Description

PIN	NAME	FUNCTION
1, 13	V _{DD}	Power Supply. Bypass V _{DD} with a 0.1µF capacitor to ground.
2	YIN	Luma Video Input. Directly connect this input to the video DAC output.
3, 8	GND	Ground
4	CVBSIN	Internal CVBS Signal Input. Directly connect this input to the video DAC output.
5	EXTCVBSIN	External CVBS Signal Input. AC-couple the signal through a 0.1µF capacitor to this input.
6	SHDN	Active-Low Shutdown Logic Input. Connect to logic low to place device in shutdown. Connect to logic high for normal operation.
7	N.C.	No Connection. Connect to GND.
9	CVBSOUT2	CVBS Output 2
10	CVBSOUT1	CVBS Output 1. CVBSOUT1 is actively pulled to GND when INT/EXT is logic high.
11	YOUT	Luma Video Output
12	COUT	Chroma Video Output
14	ĪNT/EXT	Internal/External CVBS Logic Input. Connect INT/EXT low to process CVBS video signals from CVBSIN input. Connect INT/EXT high to process CVBS video signals from EXTCVBSIN input.
15	SMARTSLEEP	SmartSleep Logic Input. Connect to logic high to activate SmartSleep operation.
16	CIN	Chroma Video Input. Directly connect this input to the video DAC output.
EP	EP	Exposed Pad. Connect EP to GND. EP is also internally connected to GND.

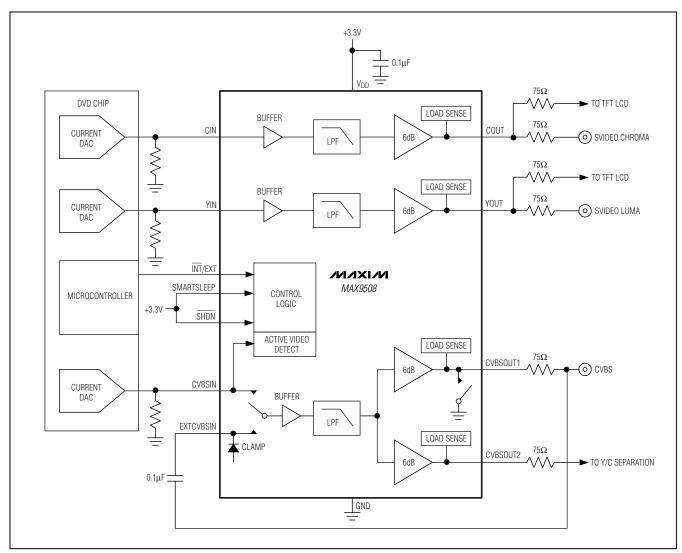


Figure 1. Typical Application Circuit for Portable DVD Player

Detailed Description

In the typical application circuit for a portable DVD player (Figure 1), the current DACs on a DVD decoder chip generate video signals. When the internal signal sources are selected, the MAX9508 filters those signals and then drives the video connectors through a 75Ω back termination resistor. When external video sources are selected, the MAX9508 selects the external composite video signal (EXTCVBSIN), filters, and amplifies it. The output stages of the amplifiers connected to

COUT, YOUT, and CVBSOUT1 become high impedance. The n-channel switch at CVBSOUT1 turns on, thereby converting the back termination resistor into an input termination resistor.

SmartSleep Feature

The SmartSleep feature is activated when the SMARTSLEEP input is connected to logic high. The SmartSleep feature provides intelligent power management by selectively disabling the filters and output amplifiers based on the presence of video signals or loads attached to the

outputs. If the SmartSleep feature is not activated and the part is not in shutdown, the filters and output amplifiers completely turn on, regardless of whether there is a video signal at the CVBSIN input and whether there are loads connected at the outputs.

SmartSleep only works with DC-coupled loads.

Standby Mode

In standby mode, the filters and output amplifiers are off and only the active video detect circuit is operational. Quiescent current consumption is approximately 7µA (Figure 2). The active video detect circuit checks if sync is present on the CVBSIN signal. If no sync is detected the device remains in standby mode.

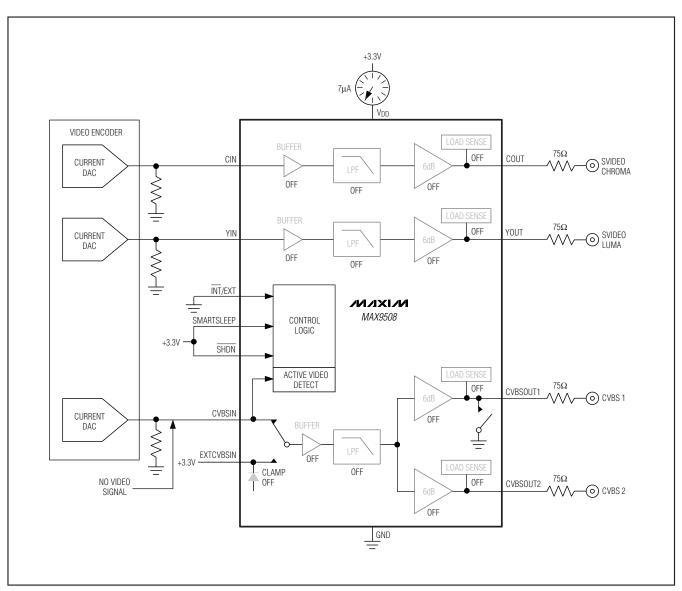


Figure 2. Standby Mode

Active-Detect Mode

The active video detect circuit slices the CVBSIN signal at 4.7% of the power supply (155mV for a 3.3V supply). If the transitions occur at a rate of 14.3kHz or higher, a video signal is present. When the MAX9508 detects a video signal with sync at the CVBSIN input, the control logic enters the active-detect mode and enables the load sense circuitry (Figure 3). The supply current is typically $17\mu A$.

If an output load is not connected to any amplifier, the MAX9508 remains in active detect mode. Eight times per second, each load-sense circuit checks for a load by connecting an internal $15k\Omega$ pullup resistor to the output for 1ms. If the output is pulled up, then no load is present. If the output stays low, a load is connected.

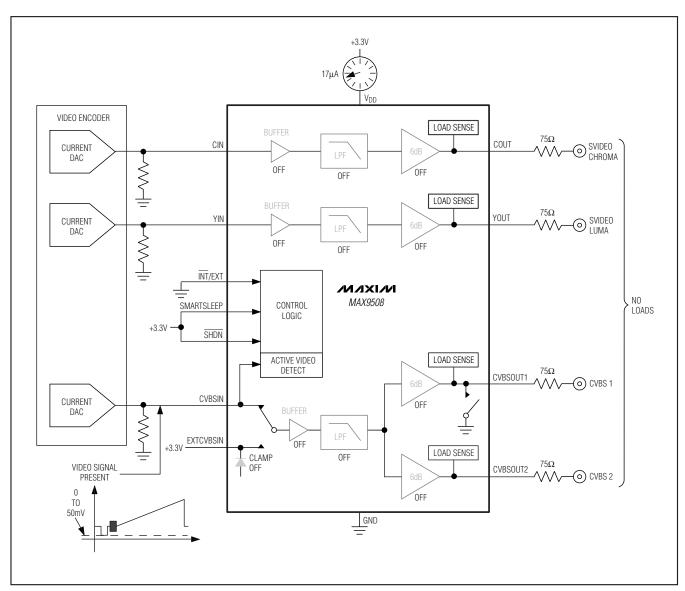


Figure 3. Active-Detect Mode with No Output Loads

Full-Operation Mode

If a load is connected to an output, the corresponding filter and amplifier turn on and remain on until the output load is disconnected. In full-operation mode, SmartSleep intelligently reduces the supply current based on the input signal presence and output loading. Figures 4, 5, and 6 show which portions of the MAX9508 turn on and which remain off with different load configurations.

When an amplifier is on, it continually checks if the load has been disconnected by detecting if the amplifier output is sourcing current during a horizontal line time. If no sourcing current is detected within one horizontal line time (approximately 64µs), the load has been disconnected and the amplifier returns to active-detect mode. If, at any time, the input video signal is removed, the MAX9508 returns to standby mode.

If the SmartSleep feature is not activated and the part is not in shutdown, the filters and amplifiers completely turn on, regardless of whether there is a video signal at the CVBSIN input and whether there are loads connected at the outputs.

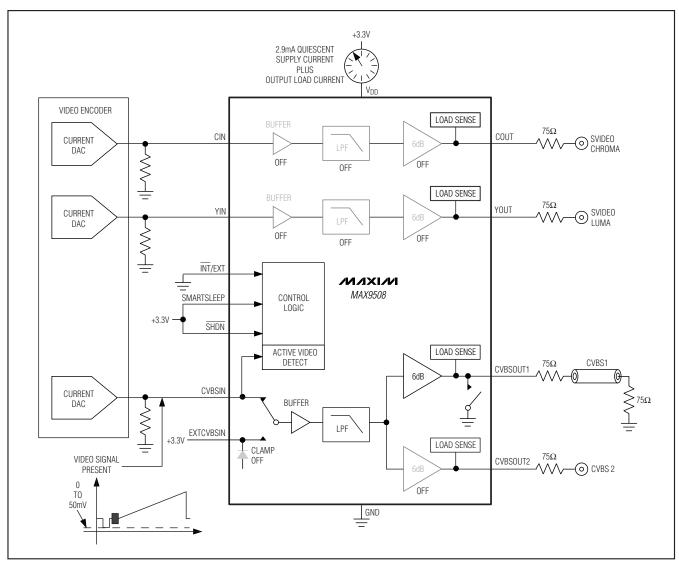


Figure 4. Full-Operation Mode with CVBSOUT1 Loaded

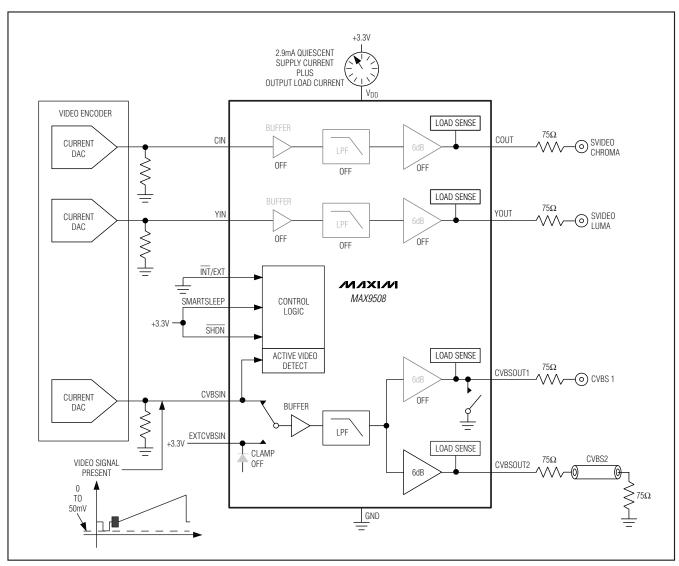


Figure 5. Full-Operation Mode with CVBSOUT2 Loaded

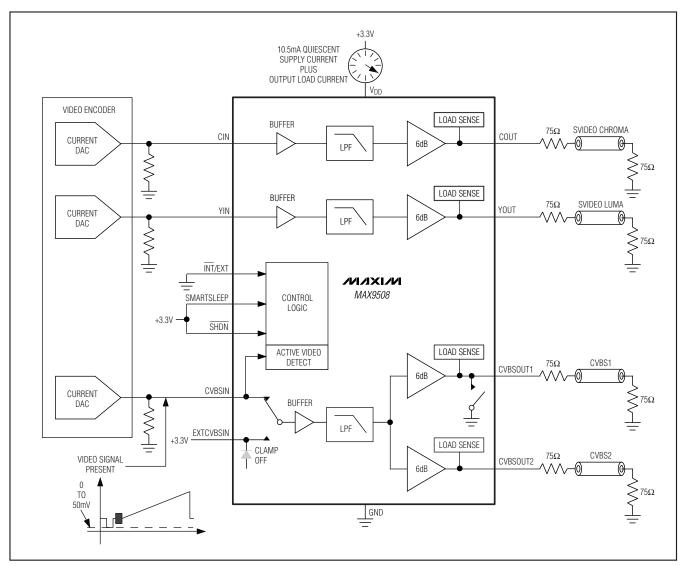


Figure 6. Full-Operation Mode with All Outputs Loaded

Internal Mode Versus External Mode Internal Mode

Set the INT/EXT control input low for internal mode. The MAX9508 processes video signals from an internal

source such as a DVD chip (Figure 7). The 2:1 multiplexer selects the video signal on CVBSIN. The EXTCVBSIN video signal is ignored.

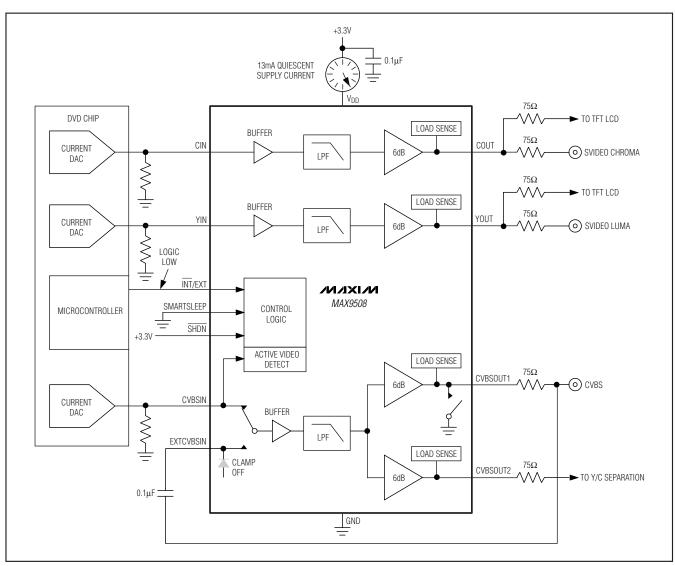


Figure 7. Internal Mode Operation for Portable DVD Applications

External Mode

Set the INT/EXT control input high for external mode. The 2:1 multiplexer selects the video signal on EXTCVBSIN (Figure 8). The YIN, CIN, and CVBSIN sig-

nals are ignored. The block drawing of the MAX9508 in Figure 8 shows which circuits are off while in external mode. SmartSleep does not function in external mode, and the SMARTSLEEP input is ignored.

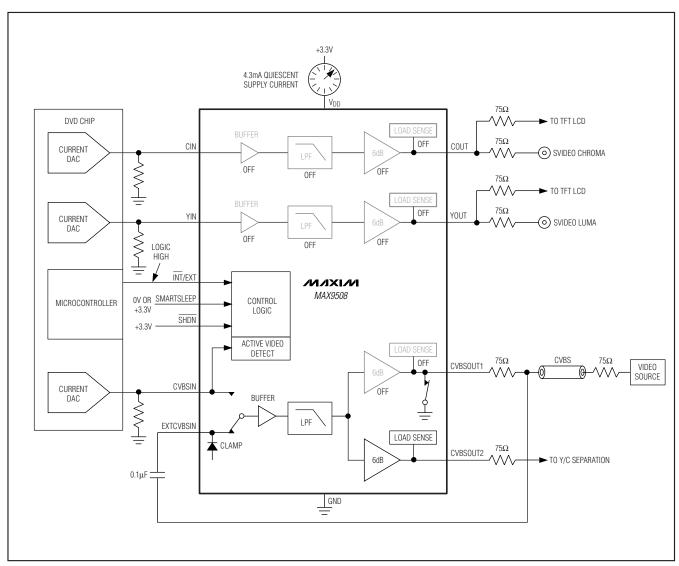


Figure 8. External Mode Operation for Portable DVD Applications

Inputs

The MAX9508 video inputs YIN, CIN, and CVBSIN should be directly connected to the output of the video current DAC. DC-coupling ensures that the input signals are ground referenced such that the sync tip of composite or luma signals is within 50mV of ground and the blank level of the chroma signal is between 0.5V and 0.65V. Since the input buffer is identical for YIN, CIN, and CVBSIN, any standard-definition video signal can be applied to those inputs as long as the signal is between ground and 1.05V when VDD = 2.7V. For example, three composite video signals could be

applied to YIN, CIN, and CVBSIN. The RGB set and the YPbPr set can also be inputs to YIN, CIN, and CVBSIN (Figure 9).

The EXTCVBSIN input can only handle signals with a sync pulse, such as composite, video, or luma. Because the DC level of an external video input signal is unknown, the external video signal is AC-coupled through a 0.1 μ F capacitor, and a sync tip clamp sets the internal DC level of the MAX9508. A 2:1 multiplexer under the control of the $\overline{\rm INT}/\rm EXT$ input selects either the signal at CVBSIN or EXTCVBSIN.

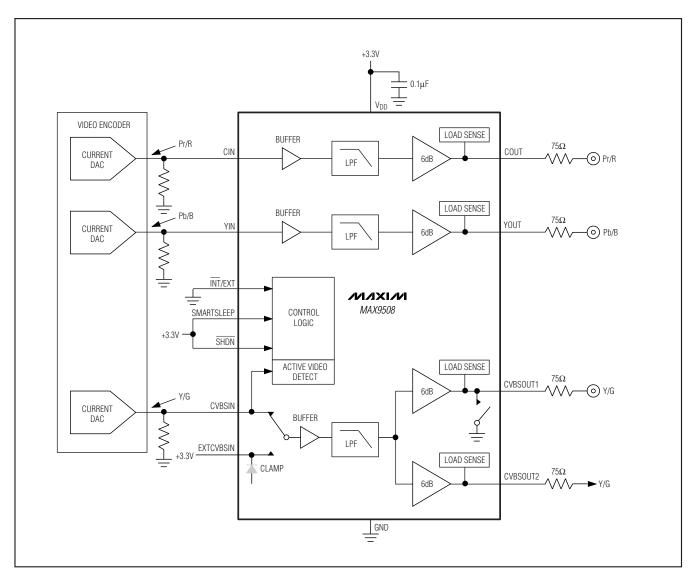


Figure 9. Y, Pr, Pb or RGB Set Applied to MAX9508

MIXIM

Video Reconstruction Filter

The MAX9508 filter passband is 6.75MHz, which makes the device suitable for the higher bandwidth video signals from a DVD chip. Broadcast video signals actually require less bandwidth because of channel limitations: NTSC signals have a 4.2MHz bandwidth, and PAL signals have a 5MHz bandwidth. Video signals from a DVD player are not channel limited; therefore, the bandwidth of DVD video signals can push right against the Nyquist limit of 6.75MHz. (Recommendation ITU-R BT.601-5 specifies 13.5MHz as the sampling rate for standard-definition video). Therefore, the maximum bandwidth of the signal is 6.75MHz. To ease the filtering requirements, most modern video systems oversample by two times, clocking the video current DAC at 27MHz.

Outputs

The video output amplifiers can both source and sink load current, allowing output loads to be DC- or AC-coupled. The amplifier output stage needs about 300mV of headroom from either supply rail. The MAX9508 has an internal level-shift circuit that positions the sync tip at approximately 300mV at the output. The blank level of the chroma output is positioned at approximately 1.3V if the blank level of the chroma input signal is 0.5V. The blank level of the chroma output is positioned at approximately 1.5V if the blank level of the chroma input signal is 0.6V.

If the supply voltage is greater than 3.135V (5% below a 3.3V supply), each amplifier can drive two DC-coupled video loads to ground. If the supply is less than 3.135V, each amplifier can drive only one DC-coupled or AC-coupled video load.

Shutdown

When \overline{SHDN} is low, the MAX9508 draws typically less than 10nA supply current. All the amplifier outputs become high impedance. The effective output resistance at the video outputs is $28k\Omega$, due to the internal feedback resistors to ground.

Applications Information

Reducing Power Consumption in the Video DACs

YIN, CIN, and CVBSIN have high-impedance input buffers and can work with source resistances as high as $300\Omega.$ To reduce power dissipation in the video DACs, the DAC output resistor can be scaled up in value. The reference resistor that sets the reference current inside the video DACs must also be similarly scaled up. For instance, if the output resistor is $37.5\Omega,$ the DAC must source 26.7mA when the output is 1V. If the output resistor is increased to $300\Omega,$ the DAC only needs to source 3.33mA when the output is 1V.

There is parasitic capacitance from the DAC output to ground. That capacitance in parallel with the DAC output resistor forms a pole that can potentially roll off the frequency response of the video signal. For example, 300Ω in parallel with 50pF creates a pole at 10.6 MHz. To minimize this capacitance, reduce the area of the signal trace attached to the DAC output as much as possible, and place the MAX9508 as close to the video DAC outputs as possible.

AC-Coupling the Outputs

The outputs can be AC-coupled since the output stage can source and sink current as shown in Figure 10. Coupling capacitors should be 220 μF or greater to keep the highpass filter formed by the 150Ω equivalent resistance of the video transmission line to a corner frequency of 4.8Hz or below. The frame rate of PAL systems is 25Hz, and the frame rate of NTSC systems is 30Hz. The corner frequency should be well below the frame rate. SmartSleep only works with DC-coupled loads.

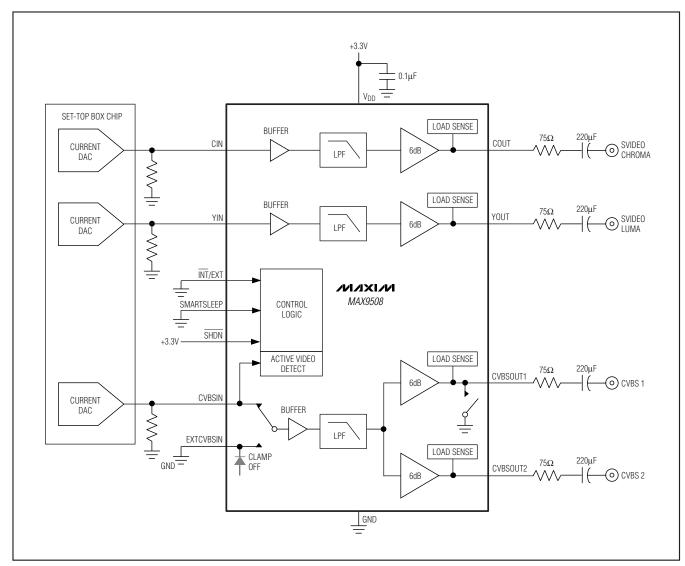
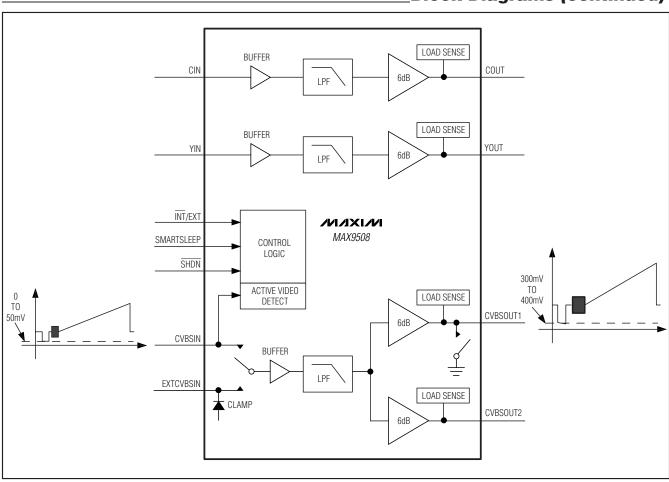


Figure 10. AC-Coupled Outputs

Power-Supply Bypassing and Ground

The MAX9508 operates from a single-supply voltage down to 2.7V, allowing for low-power operation. Bypass VDD to GND with a 0.1 μ F capacitor. Place all external components as close to the device as possible.

_Block Diagrams (continued)



Pin Configuration TOP VIEW 10 8 GND 13 V_{DD} [7 INT/EXT 14 N.C. MIXIM MAX9508 SMARTSLEEP SHDN 15 EXTCVBSIN CIN 16 THIN QFN (3mm x 3mm)

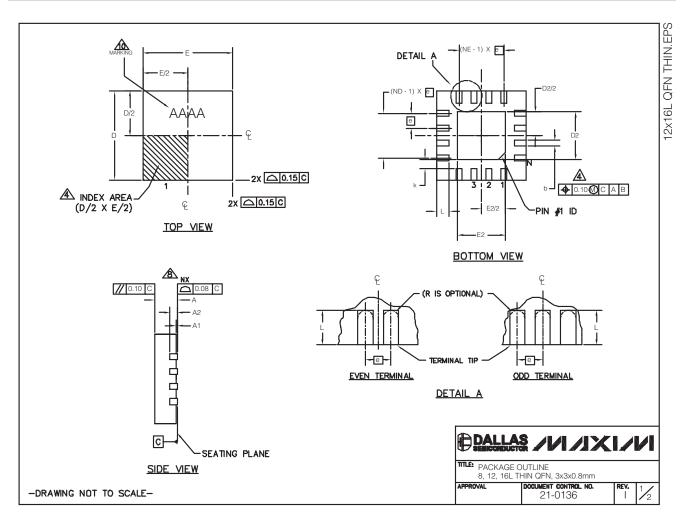
__Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
16 TQFN-EP	T1633-4	<u>21-0136</u>



Package Information (continued)

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.)

PKG	8L 3x3			1	12L 3x3			16L 3x3		
REF.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	
b	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	
D	2.90	3.00	3.10	2.90	3.00	3.10	2.90	3.00	3.10	
Е	2.90	3.00	3.10	2.90	3.00	3.10	2.90	3.00	3.10	
е	0.	.65 BS0).	0.50 BSC.			0.50 BSC.			
L	0.35	0.55	0.75	0.45	0.55	0.65	0.30	0.40	0.50	
N		8			12 3			16 4		
ND		2								
NE		2			3		4			
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	
A2	0.20 REF		0	.20 REF		0.20 REF				
k	0.25	-	-	0.25	-	-	0.25	-	-	

EXPOSED PAD VARIATIONS													
PKG.		D2			E2		PIN ID	JEDEC					
CODES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	PINID	JEDEC					
TQ833-1	0.25	0.70	1.25	0.25	0.70	1.25	0.35 x 45°	WEEC					
T1233-1	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-1					
T1233-3	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-1					
T1233-4	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-1					
T1633-2	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-2					
T1633F-3	0.65	0.80	0.95	0.65	0.80	0.95	0.225 x 45°	WEED-2					
T1633FH-3	0.65	0.80	0.95	0.65	0.80	0.95	0.225 x 45°	WEED-2					
T1633-4	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-2					
T1633-5	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45°	WEED-2					

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.

4 THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR

⚠ DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.20 mm AND 0.25 mm FROM TERMINAL TIP.

6 ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

⚠ COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS

DRAWING CONFORMS TO JEDEC MO220 REVISION C.

MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

11. NUMBER OF LEADS SHOWN ARE FOR REFERENCE, ONLY.

12. WARPAGE NOT TO EXCEED 0.10mm.



PACKAGE OUTLINE

8, 12, 16L THIN QFN, 3x3x0.8mm DOCUMENT CONTROL NO.

-DRAWING NOT TO SCALE-

21-0136

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	1/09	Removed QSOP package	1, 2, 9, 22

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